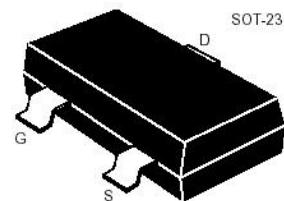


BSS84

SOT-23 場效應晶體管(SOT-23 Field Effect Transistors)



P-Channel Enhancement-Mode MOS FETs

P 溝道增強型 MOS 場效應管

■MAXIMUM RATINGS 最大額定值

Characteristic 特性參數	Symbol 符號	Rat 額定值	Unit 單位
Drain-Source Voltage 漏極-源極電壓	BV_{DSS}	-50	V
Gate- Source Voltage 柵極-源極電壓	V_{GS}	± 20	V
Drain Current (continuous) 漏極電流 - 連續	I_{DR}	-130	mA
Drain Current (pulsed) 漏極電流 - 脉冲	I_{DRM}	-520	mA

■THERMAL CHARACTERISTICS 热特性

Characteristic 特性	Symbol 符號	Max 最大值	Unit 單位
Total Device Dissipation 總耗散功率 $T_A=25^\circ\text{C}$ 環境溫度為 25°C	P_D	200	mW
Derate above 25°C 超過 25°C 遞減		1.8	$\text{mW}/^\circ\text{C}$
Thermal Resistance Junction to Ambient 热阻	$R_{\theta JA}$	350	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature 結溫和儲存溫度	T_J, T_{stg}	150°C, -55 to +150°C	



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■DEVICE MARKING 打標

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■ELECTRICAL CHARACTERISTICS 電特性

($T_A=25^\circ\text{C}$ unless otherwise noted 如無特殊說明，溫度為 25°C)

Characteristic 特性參數	Symbol 符號	Min 最小值	Typ 典型值	Max 最大值	Unit 單位
Drain-Source Breakdown Voltage 漏極-源極擊穿電壓($I_D=-250\mu\text{A}$, $V_{GS}=0\text{V}$)	BV_{DSS}	-50	—	—	V
Gate Threshold Voltage 柵極開启電壓($I_D=-250\mu\text{A}$, $V_{GS}=V_{DS}$)	$V_{GS(\text{th})}$	-1.0	—	-2.5	V
Diode Forward Voltage Drop 內附二極管正向壓降 ($I_{SD}=-200\text{mA}$, $V_{GS}=0\text{V}$)	V_{SD}	—	—	-1.5	V
Zero Gate Voltage Drain Current 零柵壓漏極電流($V_{GS}=0\text{V}$, $V_{DS}=-50\text{V}$) ($V_{GS}=0\text{V}$, $V_{DS}=-50\text{V}$, $T_A=125^\circ\text{C}$)	I_{DSS}	—	—	-15 -60	μA
Gate Body Leakage 柵極漏電流($V_{GS}=\pm20\text{V}$, $V_{DS}=0\text{V}$)	I_{GSS}	—	—	±10	nA
Static Drain-Source On-State Resistance 静态漏源導通電阻($I_D=-100\text{mA}$, $V_{GS}=-5\text{V}$)	$R_{DS(\text{ON})}$	—	—	10	Ω
Input Capacitance 輸入電容 ($V_{GS}=0\text{V}$, $V_{DS}=-25\text{V}$, $f=1\text{MHz}$)	C_{ISS}	—	73	—	pF
Common Source Output Capacitance 共源輸出電容($V_{GS}=0\text{V}$, $V_{DS}=-25\text{V}$, $f=1\text{MHz}$)	C_{OSS}	—	10	—	pF
Turn-ON Time 开启時間 ($V_{DS}=-30\text{V}$, $I_D=-270\text{mA}$, $R_{GEN}=6\Omega$)	$t_{(\text{on})}$	—	—	5	ns
Turn-OFF Time 短斷時間 ($V_{DS}=-30\text{V}$, $I_D=-270\text{mA}$, $R_{GEN}=6\Omega$)	$t_{(\text{off})}$	—	—	20	ns
Reverse Recovery Time 反向恢复時間 ($I_{SD}=-100\text{mA}$, $V_{GS}=0\text{V}$)	t_{rr}	—	10	—	ns

- FR-5= $1.0 \times 0.75 \times 0.062\text{in.}$
- Alumina= $0.4 \times 0.3 \times 0.024\text{in.}$ 99.5%alumina.
- Pulse Width $\leq 300\mu\text{s}$; Duty Cycle $\leq 2.0\%$.

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■ TYPICAL CHARACTERISTIC CURVE 典型特性

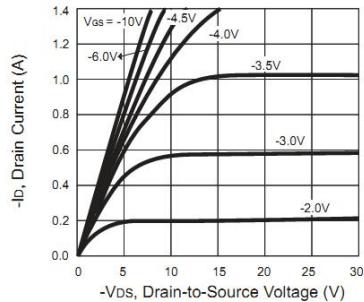


Figure 1. Output Characteristics

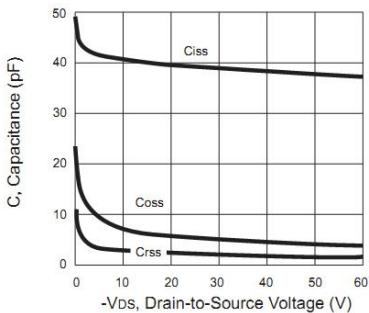


Figure 3. Capacitance

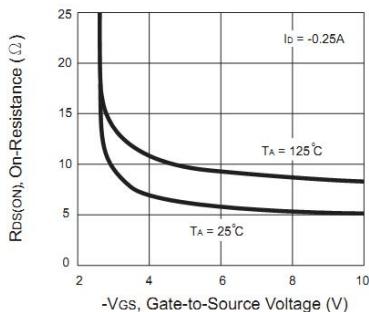


Figure 5. On-Resistance Variation with Gate-to-Source Voltage.

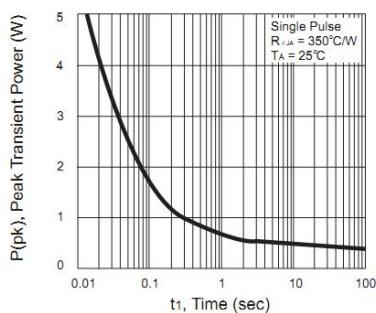


Figure 7. Single Pulse Maximum Power Dissipation

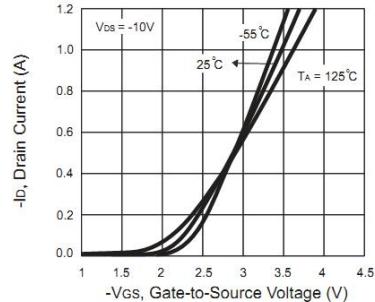


Figure 2. Transfer Characteristics

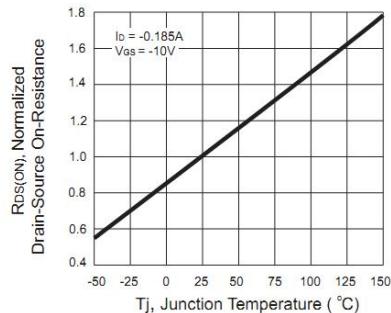


Figure 4. On-Resistance Variation with Temperature

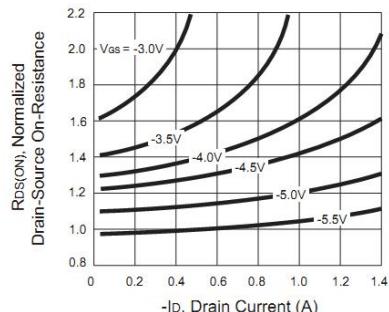


Figure 6. On-Resistance Variation with Drain Current and Gate Voltage.

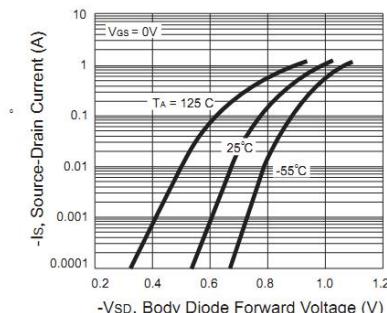


Figure 8. Body Diode Forward Voltage Variation with Source Current